



FQB14N30 / FQI14N30

300V N-Channel MOSFET

General Description

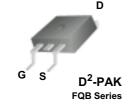
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

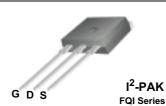
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply.

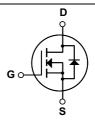
Features

- 14.4A, 300V, $R_{DS(on)}$ = 0.29 Ω @V_{GS} = 10 V Low gate charge (typical 30 nC)
- Low Crss (typical 23 pF)
- · Fast switching
- · 100% avalanche tested
- · Improved dv/dt capability
- · RoHS Compliant









Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQB14N30 / FQI14N30	Units
V _{DSS}	Drain-Source Voltage		300	V
I _D	Drain Current - Continuous (T _C = 25°C)		14.4	Α
	- Continuous (T _C = 100°C))	9.1	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	57.6	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	600	mJ
I _{AR}	Avalanche Current	(Note 1)	14.4	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	14.7	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
P _D	Power Dissipation (T _A = 25°C) *		3.13	W
	Power Dissipation (T _C = 25°C)		147	W
	- Derate above 25°C		1.18	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.85	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

^{*} When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	300			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.34		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 300 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 240 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 7.2 A		0.23	0.29	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 7.2 A (Note 4)		9.5		S
C _{oss}	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz		200 23	260 30	pF pF
	1			23	30	pF
	ing Characteristics	I		00		
t _{d(on)}	Turn-On Delay Time	V _{DD} = 150 V, I _D = 14.4 A,		22	55	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		145	300	ns
t _{d(off)}	Turn-Off Delay Time	(Note 4, 5)		45 70	100 150	ns
t _f	Turn-Off Fall Time					ns
Q _g	Total Gate Charge Gate-Source Charge	$V_{DS} = 240 \text{ V}, I_D = 14.4 \text{ A},$		30 7.5	40	nC nC
Q _{gs}	Gate-Drain Charge	V _{GS} = 10 V (Note 4, 5)		13		nC
∝ ga	Gate-Drain Charge	(, .,		13		110
Drain-S	Source Diode Characteristics ar	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Dic	ode Forward Current			14.4	Α
	Maximum Pulsed Drain-Source Diode F	orward Current			57.6	Α
I _{SM}				. —	. —	
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 14.4 \text{ A}$			1.5	V
		$V_{GS} = 0 \text{ V, } I_S = 14.4 \text{ A}$ $V_{GS} = 0 \text{ V, } I_S = 14.4 \text{ A,}$ $dI_{C} / dt = 100 \text{ A/us} \qquad \text{(Note 4)}$		200	1.5	V ns

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 4.8mH, I_{AS} = 14.4A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C 3. I_{SD} \leq 14.4A, di/dt \leq 200A/μs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300μs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Typical Characteristics

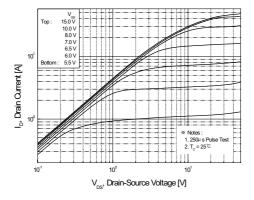


Figure 1. On-Region Characteristics

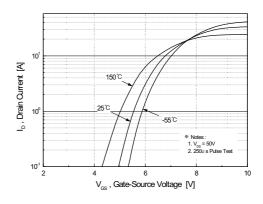


Figure 2. Transfer Characteristics

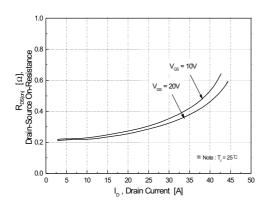


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

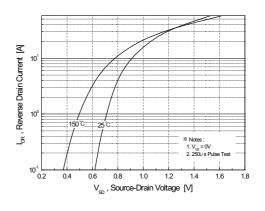


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

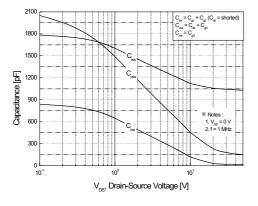


Figure 5. Capacitance Characteristics

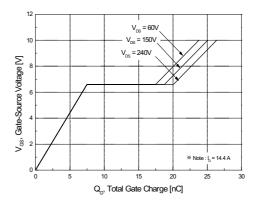
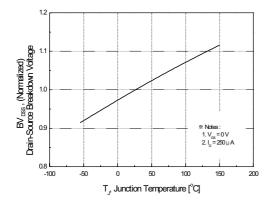


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)



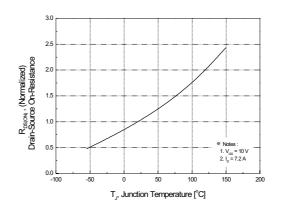
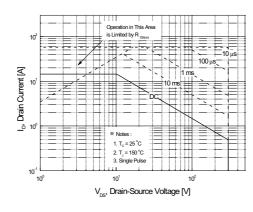


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



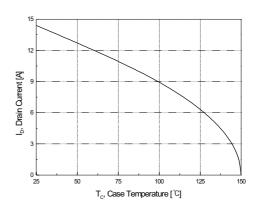


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

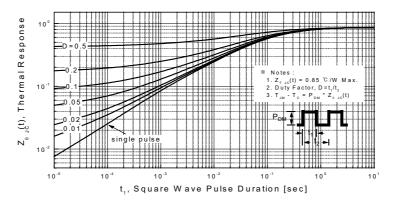
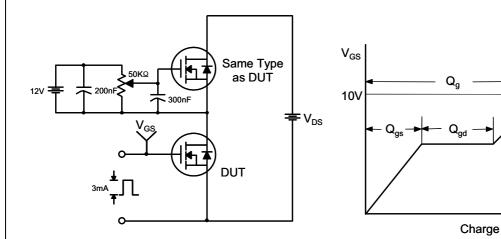
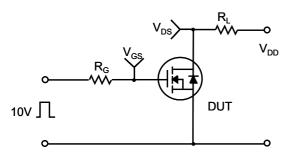


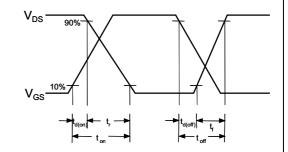
Figure 11. Transient Thermal Response Curve

Gate Charge Test Circuit & Waveform

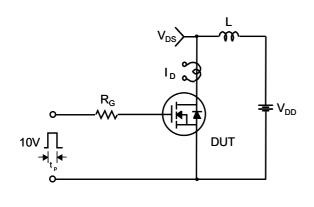


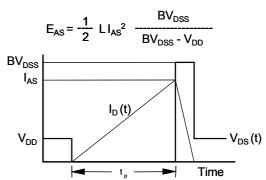
Resistive Switching Test Circuit & Waveforms



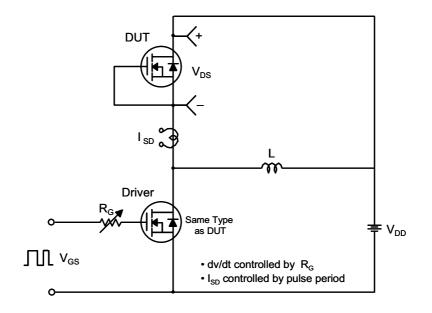


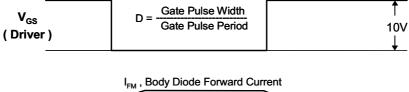
Unclamped Inductive Switching Test Circuit & Waveforms

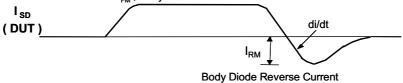


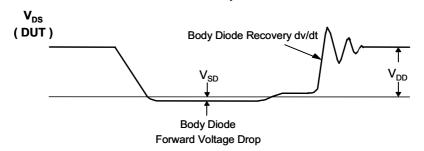


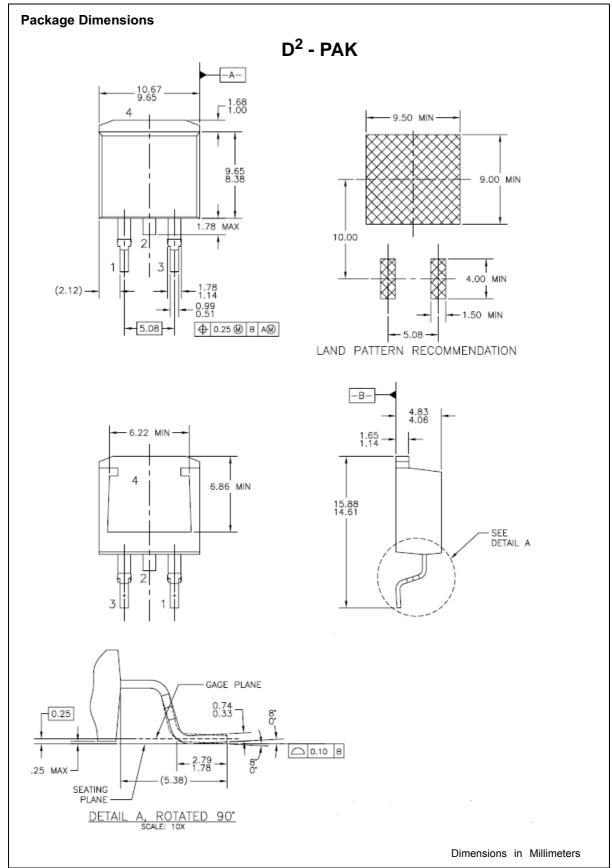
Peak Diode Recovery dv/dt Test Circuit & Waveforms

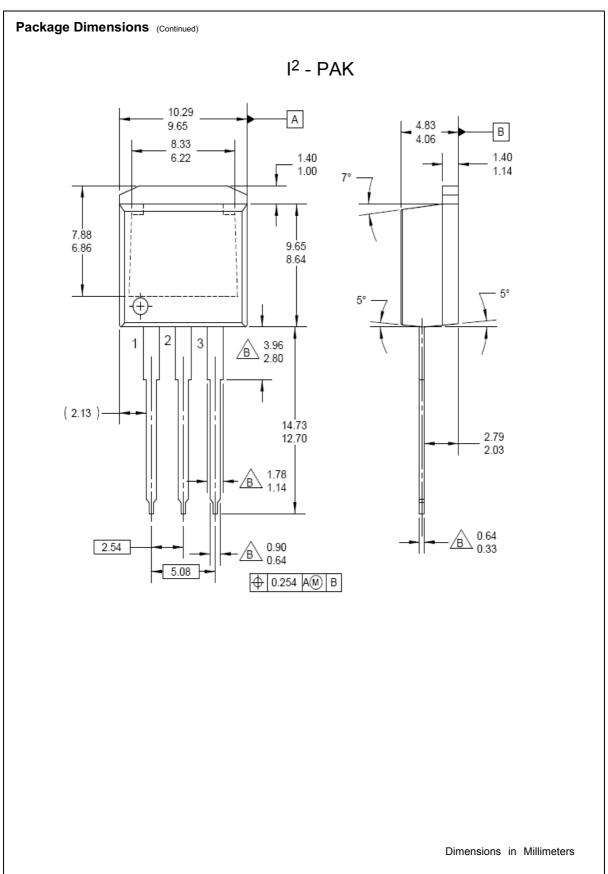
















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